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Datasheet of LM810M3X-4.63/NOPB - IC CIRC RESET 3PIN MCRO SOT23-3 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



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LM809, LM810

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# LM809/LM810 3-Pin Microprocessor Reset Circuits

#### 1 Features

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- Precision Monitoring of Supply Voltages
  - Available Threshold Options: 2.63 V, 2.93 V, 3.08 V, 4.38 V, 4.63 V
- Superior Upgrade to MAX809 and MAX810
- Fully Specified Over Temperature
- 140-ms Minimum Power-On Reset Pulse Width, 240-ms Typical

Product

Folder

- Active-Low RESET Output (LM809)
- Active-High RESET Output (LM810)
- Ensured RESET Output Valid for  $V_{CC} \ge 1 V$
- Low Supply Current, 15-µA Typical
- Power Supply Transient Immunity

#### Applications 2

- **Factory Automation**
- **Building Automation**
- Programmable Logic Control
- Renewable Energy
- Microprocessor Systems
- Computers
- Controllers
- Intelligent Instruments
- Portable/Battery-Powered Equipment
- Automotive

# 3 Description

The LM809 and LM810 microprocessors supervisory circuits can be used to monitor the power supplies in microprocessor and digital systems. They provide a reset to the microprocessor during power-up, powerdown and brown-out conditions.

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The function of the LM809 and LM810 are to monitor the V<sub>CC</sub> supply voltage, and assert a reset signal whenever this voltage declines below the factoryprogrammed reset threshold. The reset signal remains asserted for 240 ms after V<sub>CC</sub> rises above the threshold. The LM809 has an active-low RESET output, while the LM810 has an active-high RESET output.

Seven standard reset voltage options are available, suitable for monitoring 5-V, 3.3-V, and 3-V supply voltages.

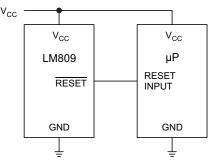
With a low supply current of only 15 µA, the LM809 and LM810 are ideal for use in portable equipment.

## Device Information<sup>(1)</sup>

| PART NUMBER  | PACKAGE BODY SIZE (N |                   |
|--------------|----------------------|-------------------|
| LM809, LM810 | SOT-23 (3)           | 2.92 mm × 1.30 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

# **Typical Application for Microprocessor Reset Circuit**







#### LM809, LM810

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# 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | hanges from Revision D (May 2013) to Revision E |
|----|---|
|    | Removed the SON package                         |

| • | Removed the SON package.  | 1 |
|---|---|---|
| • | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation |   |
|   | section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and  |   |
|   | Mechanical, Packaging, and Orderable Information section.   | 1 |

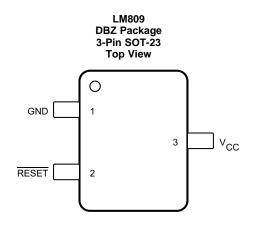


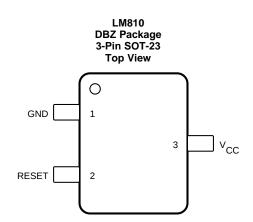
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# 5 Pin Configuration and Functions





#### **Pin Functions**

| PIN             |         |       |     |  |
|-----------------|---------|-------|-----|--|
| NAME            | NO. I/O |       | I/O | DESCRIPTION  |
|                 | LM809   | LM810 |     |  |
| RESET           | 2       | -     | 0   | Active-low output. $\overline{\text{RESET}}$ remains low while $V_{CC}$ is below the reset threshold, and for 240 ms after $V_{CC}$ rises above the reset threshold. |
| RESET           | _       | 2     | 0   | Active-high output. RESET remains high while $V_{CC}$ is below the reset threshold, and for 240 ms after $V_{CC}$ rises above the reset threshold.                   |
| V <sub>CC</sub> | 3       | 3     | Ι   | Supply voltage   |
| GND             | 1       | 1     | —   | Ground reference   |



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# 6 Specifications

# 6.1 Absolute Maximum Ratings

see (1)(2)

|   |                 | MIN  | MAX                   | UNIT |
|---|-----------------|------|-----------------------|------|
| Input supply voltage                              | V <sub>CC</sub> | -0.3 | 6                     | V    |
| Output voltage                                    | RESET, RESET    | -0.3 | V <sub>CC</sub> + 0.3 | V    |
| Input current                                     | V <sub>CC</sub> |      | 20                    | mA   |
| Output current                                    | RESET, RESET    |      | 20                    | mA   |
| Rate of rise                                      | V <sub>CC</sub> |      | 100                   | V/µs |
| Continuous power dissipation                      |                 |      | 320                   | mW   |
| Lead temperature (soldering, 10 s)                |                 |      | 300                   | °C   |
| Ambient temperature range, T <sub>A</sub>         |                 | -40  | 105                   | °C   |
| Maximum junction temperature, T <sub>J(MAX)</sub> |                 |      | 125                   | °C   |
| Storage temperature, T <sub>stg</sub>             |                 | -65  | 160                   | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

# 6.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V                  | Electrostatia discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±200  | V    |

 JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions. Pins listed as ±2000 V may actually have higher performance.
JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with

less than 250-V CDM is possible with the necessary precautions. Pins listed as ±200 V may actually have higher performance.

# 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                 |                     |  |  | MIN | NOM | MAX | UNIT |
|-----------------|---------------------|--|--|-----|-----|-----|------|
| V               |                     |  | $T_A = 0^{\circ}C$ to $70^{\circ}C$    | 1.0 |     | 5.5 | V    |
| V <sub>CC</sub> | Input voltage range | tage range   | $T_A = -40^{\circ}C$ to $105^{\circ}C$ | 1.2 |     | 5.5 | V    |
| I <sub>CC</sub> |                     | Supply Current<br>V <sub>CC</sub> < 5.5 V,<br>LM8xx: 4.63, 4.38, 4.00<br>V <sub>CC</sub> < 3.6 V,<br>LM8xx: 3.08, 2.93, 2.63, 2.45 | $T_A = -40^{\circ}C$ to $85^{\circ}C$  |     | 18  | 60  |      |
|                 | Supply Current      |  | $T_A = 85^{\circ}C$ to $105^{\circ}C$  |     |     | 100 |      |
|                 | Supply Current      |  | $T_A = -40^{\circ}C$ to $85^{\circ}C$  |     | 15  | 50  | μA   |
|                 |                     |  | $T_A = 85^{\circ}C$ to $105^{\circ}C$  |     |     | 100 |      |

### 6.4 Thermal Information

|                       |  | LM809, LM810 |      |
|-----------------------|--|--------------|------|
|                       | THERMAL METRIC <sup>(1)</sup>                | DBZ (SOT-23) | UNIT |
|                       |  | 3 PINS       |      |
| $R_{\theta J A}$      | Junction-to-ambient thermal resistance       | 252.0        | °C/W |
| R <sub>0JC(top)</sub> | Junction-to-case (top) thermal resistance    | 113.3        | °C/W |
| $R_{\theta JB}$       | Junction-to-board thermal resistance         | 53.5         | °C/W |
| ΨJT                   | Junction-to-top characterization parameter   | 9.9          | °C/W |
| Ψ <sub>JB</sub>       | Junction-to-board characterization parameter | 52.6         | °C/W |
| R <sub>0JC(bot)</sub> | Junction-to-case (bottom) thermal resistance | —            | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

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# 6.5 Electrical Characteristics

 $V_{CC}$  = full range,  $T_A$  = -40°C to 105°C, unless otherwise noted. Typical values are at  $T_A$  = 25°C,  $V_{CC}$  = 5 V for 4.63, 4.38, and 4.00 versions,  $V_{CC}$  = 3.3 V for 3.08 and 2.93 versions, and  $V_{CC}$  = 3 V for 2.63 and 2.45 version<sup>(1)</sup>.

|   | PARAMETER                            | TEST CO  | TEST CONDITIONS                       |                       | TYP  | MAX  | UNIT   |  |
|---|--------------------------------------|--|---------------------------------------|-----------------------|------|------|--------|--|
|   |                                      |  | T <sub>A</sub> = 25°C                 | 4.56                  | 4.63 | 4.70 |        |  |
|   |                                      | LM8xx: 4.63 V  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 4.50                  |      | 4.75 | -      |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 4.40                  |      | 4.86 |        |  |
|   |                                      | LM8xx: 4.38 V<br>$T_A = 25^{\circ}C$<br>$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$<br>$T_A = 85^{\circ}C \text{ to } 105^{\circ}C$ | T <sub>A</sub> = 25°C                 | 4.31                  | 4.38 | 4.45 |        |  |
|   |                                      |  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 4.25                  |      | 4.50 |        |  |
|   |                                      |  | 4.16                                  |                       | 4.56 |      |        |  |
|   |                                      |  | T <sub>A</sub> = 25°C                 | 3.93                  | 4.00 | 4.06 |        |  |
|   |                                      | LM8xx: 4.00 V  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 3.89                  |      | 4.10 |        |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 3.80                  |      | 4.20 |        |  |
|   |                                      |  | T <sub>A</sub> = 25°C                 | 3.04                  | 3.08 | 3.11 |        |  |
| V <sub>TH</sub>   | Reset Threshold <sup>(2)</sup>       | LM8xx: 3.08 V  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 3.00                  |      | 3.15 | V      |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 2.92                  |      | 3.23 |        |  |
|   |                                      |  | T <sub>A</sub> = 25°C                 | 2.89                  | 2.93 | 2.96 |        |  |
|   |                                      | LM8xx: 2.93 V  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 2.85                  |      | 3.00 |        |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 2.78                  |      | 3.08 |        |  |
|   |                                      | LM8xx: 2.63 V<br>LM8xx: 2.45 V   | T <sub>A</sub> = 25°C                 | 2.59                  | 2.63 | 2.66 | -      |  |
|   |                                      |  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 2.55                  |      | 2.70 |        |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 2.50                  |      | 2.76 |        |  |
|   |                                      |  | T <sub>A</sub> = 25°C                 | 2.41                  | 2.45 | 2.49 |        |  |
|   |                                      |  | $T_A = -40^{\circ}C$ to $85^{\circ}C$ | 2.38                  |      | 2.52 |        |  |
|   |                                      |  | T <sub>A</sub> = 85°C to 105°C        | 2.33                  |      | 2.57 |        |  |
| Reset Threshold<br>Temperature Coefficient<br>V <sub>CC</sub> to Reset Delay <sup>(2)</sup> |                                      |  |                                       |                       | 30   |      | ppm/°C |  |
|   |                                      | $V_{CC} = V_{TH}$ to ( $V_{TH} - 100$ mV)  |                                       |                       | 20   |      | μs     |  |
| Reset Active Timeout<br>Period  |                                      | $T_A = -40^{\circ}C \text{ to } 85^{\circ}C$   |                                       | 140                   | 240  | 560  |        |  |
|   |                                      | $T_A = 85^{\circ}C \text{ to } 105^{\circ}C$   |                                       | 100                   |      | 840  | ms     |  |
|   |                                      | $V_{CC} = V_{TH(min)}$ , $I_{SINK} = 1.2$ mA, L  | M809: 2.45, 2.63, 2.93, 3.08          |                       |      | 0.3  |        |  |
|   | RESET Output Voltage<br>Low (LM809)  | $V_{CC} = V_{TH(min)}$ , $I_{SINK} = 3.2$ mA, L  | M809: 4.63, 4.38, 4.00                |                       |      | 0.4  | 1      |  |
| V <sub>OL</sub>   |                                      | $V_{CC} > 1 \text{ V}, \text{ I}_{SINK} = 50 \mu\text{A}$  |                                       |                       |      | 0.3  | V      |  |
| 01  | RESET Output Voltage                 | $V_{CC} = V_{TH(max)}$ , $I_{SINK} = 1.2 \text{ mA}$ , LM810: 2.63, 2.93, 3.08   |                                       |                       |      | 0.3  |        |  |
|   | Low (LM810)                          | $V_{CC} = V_{TH(max)}$ , $I_{SINK} = 3.2$ mA, LM810: 4.63, 4.38, 4.00  |                                       |                       |      | 0.4  |        |  |
|   | RESET Output Voltage                 | $V_{CC} > V_{TH(max)}$ , $I_{SOURCE} = 500 \ \mu$  |                                       | 0.8 × V <sub>CC</sub> |      |      |        |  |
| 1.  | High (LM809)                         | $V_{CC} > V_{TH(max)}$ , $I_{SOURCE} = 800 \ \mu M$  |                                       | V <sub>CC</sub> – 1.5 |      |      | V      |  |
| V <sub>ОН</sub>   | RESET Output Voltage<br>High (LM810) | $1.8 \text{ V} < \text{V}_{\text{CC}} < \text{V}_{\text{TH(min)}}, \text{I}_{\text{SOURCE}} =$                                       |                                       | 0.8 × V <sub>CC</sub> |      |      | v      |  |

 $\frac{Production}{RESET}$  Output for LM809, RESET output for LM810. (1)

(2)



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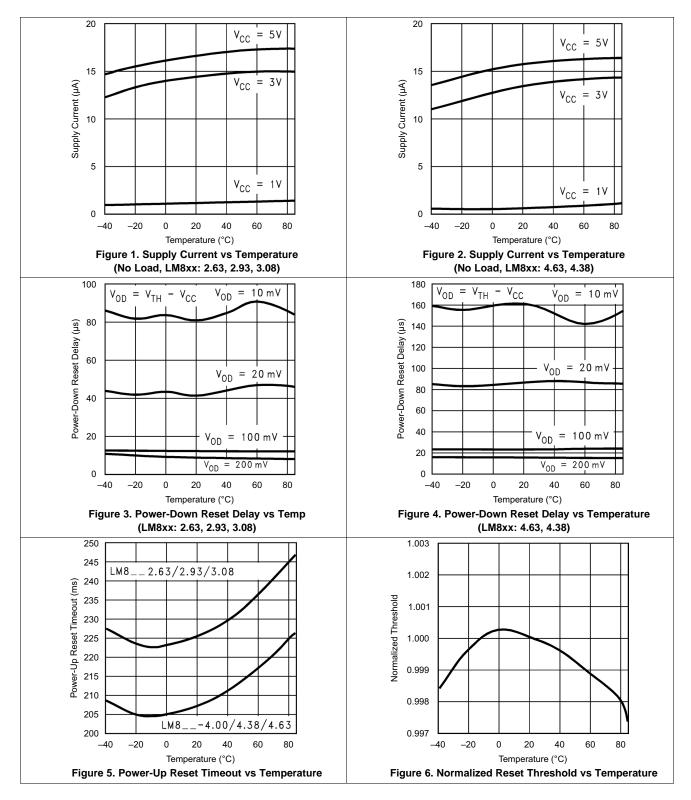
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# 6.6 Typical Characteristics





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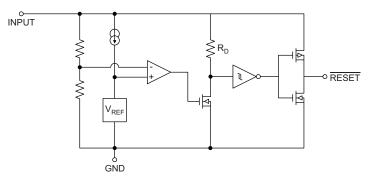
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# 7 Detailed Description

# 7.1 Overview

The LM809 and LM810 microprocessor supervisory circuits provide a simple solution to monitor the power supplies in microprocessor and digital systems and provide a reset during power-up, power-down, and brown-out conditions. The reset signal is controlled by the factory-programmed reset threshold on the V<sub>CC</sub> supply voltage pin. When the voltage declines below the reset threshold, the reset signal is asserted and remains asserted for 240 ms after V<sub>CC</sub> rises above the threshold. The LM809 has an active-low RESET output, while the LM810 has an active-high RESET output. The available threshold options are 2.63 V, 2.93 V, 3.08 V, 4.38 V, and 4.63 V to provide precision monitoring of supply voltages.

# 7.2 Functional Block Diagram



# 7.3 Feature Description

# 7.3.1 Benefits of Precision Reset Thresholds

A microprocessor supply supervisor must provide a reset output within a predictable range of the supply voltage. A common threshold range is between 5% and 10% below the nominal supply voltage. The 4.63-V and 3.08-V options of the LM809 and LM810 use highly accurate circuitry to ensure that the reset threshold occurs only within this range (for 5-V and 3.3-V supplies). The other voltage options have the same tight tolerance to ensure a reset signal for other narrow monitor ranges. See Table 1 for examples of how the standard reset thresholds apply to 3-V, 3.3-V, and 5-V nominal supply voltages.

| Table 1. | Reset | Thresholds | Related to | Common | Supply Voltages |
|----------|-------|------------|------------|--------|-----------------|
|----------|-------|------------|------------|--------|-----------------|

| Reset Threshold | 3 V      | 3.3 V    | 5 V      |
|-----------------|----------|----------|----------|
| 4.63 ± 3%       |          |          | 90 – 95% |
| 4.38 ± 3%       |          |          | 85 – 90% |
| 4.00 ± 3%       |          |          | 78 – 82% |
| 3.08 ± 3%       |          | 90 – 95% |          |
| 2.93 ± 3%       |          | 86 - 90% |          |
| 2.63 ± 3%       | 85 – 90% | 77 – 81% |          |
| 2.45 ± 3%       | 79 – 84% | 72 – 76% |          |

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## 7.3.1.1 Ensuring a Valid Reset Output Down to $V_{CC} = 0 V$

When  $V_{CC}$  falls below 1 V, the LM809 RESET output no longer sinks current. A high-impedance CMOS logic input connected to RESET can therefore drift to undetermined voltages. To prevent this situation, a 100-k $\Omega$  resistor should be connected from the RESET output to ground, as shown in Figure 7.

A 100-k $\Omega$  pullup resistor to V<sub>CC</sub> is also recommended for the LM810, if RESET is required to remain valid for V<sub>CC</sub> < 1 V.

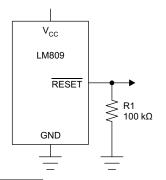


Figure 7. **RESET** Valid to  $V_{CC}$  = Ground Circuit

## 7.3.1.2 Negative-Going V<sub>CC</sub> Transients

The LM809 and LM810 are relatively immune to short negative-going transients or glitches on V<sub>CC</sub>. Figure 8 shows the maximum pulse width a negative-going V<sub>CC</sub> transient can have without causing a reset pulse. In general, as the magnitude of the transient increases, going further below the threshold, the maximum allowable pulse width decreases. Typically, for the 4.63-V and 4.38-V version of the LM809 or LM810, a V<sub>CC</sub> transient that goes 100 mV below the reset threshold and lasts 20  $\mu$ s or less will not cause a reset pulse. A 0.1- $\mu$ F bypass capacitor mounted as close as possible to the V<sub>CC</sub> pin will provide additional transient rejection.

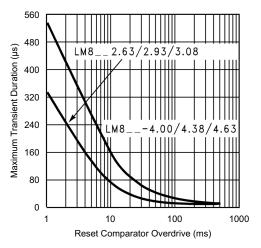


Figure 8. Maximum Transient Duration without Causing a Reset Pulse vs Reset Comparator Overdrive



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# 7.3.1.3 Interfacing to µPs with Bidirectional Reset Pins

Microprocessors with bidirectional reset pins, such as the Motorola 68HC11 series, can be connected to the LM809 RESET output. To ensure a correct output on the LM809 even when the microprocessor reset pin is in the opposite state, connect a  $4.7 + \Omega$  resistor between the LM809 RESET output and the  $\mu$ P reset pin, as shown in Figure 9. Buffer the LM809 RESET output to other system components.

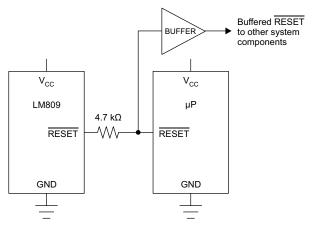


Figure 9. Interfacing to Microprocessors with Bidirectional Reset I/O

# 7.4 Device Functional Modes

# 7.4.1 V<sub>CC</sub> Supply Voltage Low

When  $V_{CC}$  supply voltage declines below the reset threshold, the RESET output is asserted. For LM809, the active-low RESET output is low. For LM810, the active-high RESET output is high.

# 7.4.2 V<sub>CC</sub> Supply Voltage High

When the  $V_{CC}$  supply voltage rises above the reset threshold, the RESET output resets after 240 ms. For LM809, the active-low RESET output rises high. For LM810, the active-high RESET output drops low.



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# 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

# 8.1 Application Information

The LM809 and LM810 are a supervisor circuit for microprocessor and digital systems. With a low supply current of only 15 µA, the LM809 and LM810 are ideal for use in portable equipment.

# 8.2 Typical Application

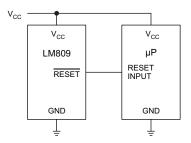


Figure 10. Microprocessor RESET Circuit

## 8.2.1 Design Requirements

For this design example, use the parameters listed in Table 2 as the input parameters.

### **Table 2. Design Parameters**

| DESIGN PARAMETER            | EXAMPLE VALUE |
|-----------------------------|---------------|
| Input supply voltage range  | 1 V to 5.5 V  |
| Reset output voltage (high) | Input supply  |
| Reset output voltage (low)  | 0 V           |

### 8.2.2 Detailed Design Procedure

For the typical application circuit, all that is required is the LM809 or LM810 IC, but TI recommends an input capacitor to help with input voltage transients. A typical input capacitor value is 0.1 uF and must be rated for the highest expected input voltage.



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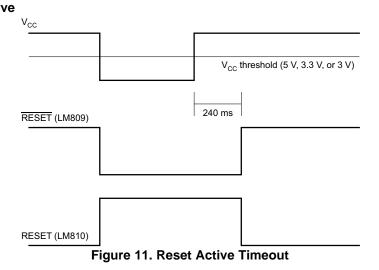
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# 8.2.3 Application Curve



# 9 Power Supply Recommendations

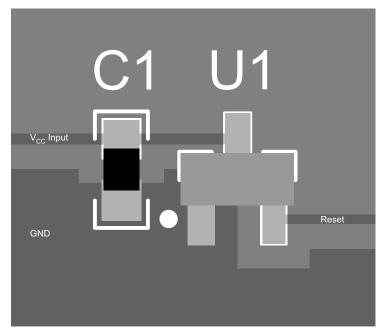
The input of the LM809 is designed to handle up to the supply voltage absolute maximum rating of 6.5 V. If the input supply is susceptible to any large transients above the maximum rating, then extra precautions should be taken. An input capacitor is recommended to avoid false reset output triggers due to noise.

# 10 Layout

# 10.1 Layout Guidelines

Place the input capacitor as close as possible to the IC.

# 10.2 Layout Example







### LM809, LM810

SNVS052E-SEPTEMBER 1999-REVISED APRIL 2016



www.ti.com

# **11 Device and Documentation Support**

# 11.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

| Table 3. R | elated | Links |
|------------|--------|-------|
|------------|--------|-------|

| PARTS | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL<br>DOCUMENTS | TOOLS &<br>SOFTWARE | SUPPORT &<br>COMMUNITY |
|-------|----------------|--------------|------------------------|---------------------|------------------------|
| LM809 | Click here     | Click here   | Click here             | Click here          | Click here             |
| LM810 | Click here     | Click here   | Click here             | Click here          | Click here             |

## **11.2 Community Resources**

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## 11.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

# 11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# 11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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### PACKAGING INFORMATION

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| Orderable Device   | Status | Package Type |         | Pins |      | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|--------------------|--------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------|---------|
|                    | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                |              | (4/5)          |         |
| LM809M3-2.63       | NRND   | SOT-23       | DBZ     | 3    | 1000 | TBD                        | Call TI          | Call TI            | -40 to 105   | S3B            |         |
| LM809M3-2.63/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S3B            | Samples |
| LM809M3-2.93       | NRND   | SOT-23       | DBZ     | 3    | 1000 | TBD                        | Call TI          | Call TI            | -40 to 105   | S4B            |         |
| LM809M3-2.93/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S4B            | Samples |
| LM809M3-3.08       | NRND   | SOT-23       | DBZ     | 3    | 1000 | TBD                        | Call TI          | Call TI            | -40 to 105   | S5B            |         |
| LM809M3-3.08/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S5B            | Samples |
| LM809M3-4.38/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S7B            | Samples |
| LM809M3-4.63/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S8B            | Samples |
| LM809M3X-2.63/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S3B            | Samples |
| LM809M3X-2.93/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S4B            | Samples |
| LM809M3X-3.08/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S5B            | Samples |
| LM809M3X-4.38/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM |              | S7B            | Samples |
| LM809M3X-4.63/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | S8B            | Samples |
| LM810M3-4.63       | NRND   | SOT-23       | DBZ     | 3    | 1000 | TBD                        | Call TI          | Call TI            | -40 to 105   | SEB            |         |
| LM810M3-4.63/NOPB  | ACTIVE | SOT-23       | DBZ     | 3    | 1000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | SEB            | Samples |
| LM810M3X-4.63/NOPB | ACTIVE | SOT-23       | DBZ     | 3    | 3000 | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM | -40 to 105   | SEB            | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

Addendum-Page 1



3-Nov-2015

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above. Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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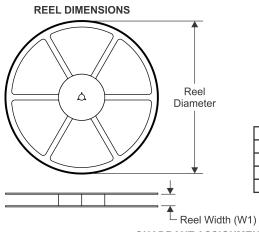
TEXAS INSTRUMENTS

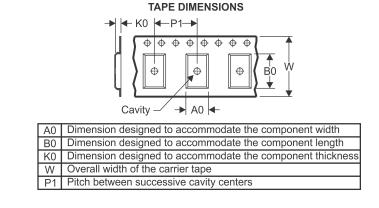
# PACKAGE MATERIALS INFORMATION

3-Nov-2015

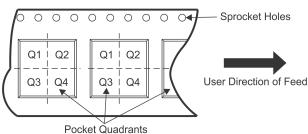
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# TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device             | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LM809M3-2.63       | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-2.63/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-2.93       | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-2.93/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-3.08       | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-3.08/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-4.38/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3-4.63/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3X-2.63/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3X-2.93/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3X-3.08/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3X-4.38/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM809M3X-4.63/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM810M3-4.63       | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM810M3-4.63/NOPB  | SOT-23          | DBZ                | 3    | 1000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |
| LM810M3X-4.63/NOPB | SOT-23          | DBZ                | 3    | 3000 | 178.0                    | 8.4                      | 3.3        | 2.9        | 1.22       | 4.0        | 8.0       | Q3               |



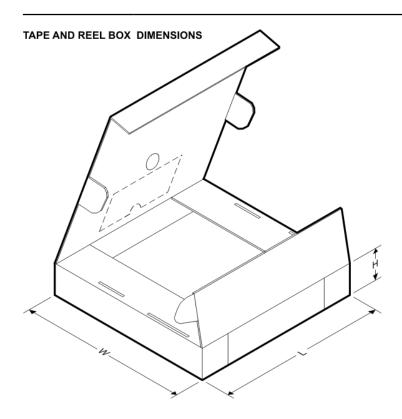
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# PACKAGE MATERIALS INFORMATION

3-Nov-2015



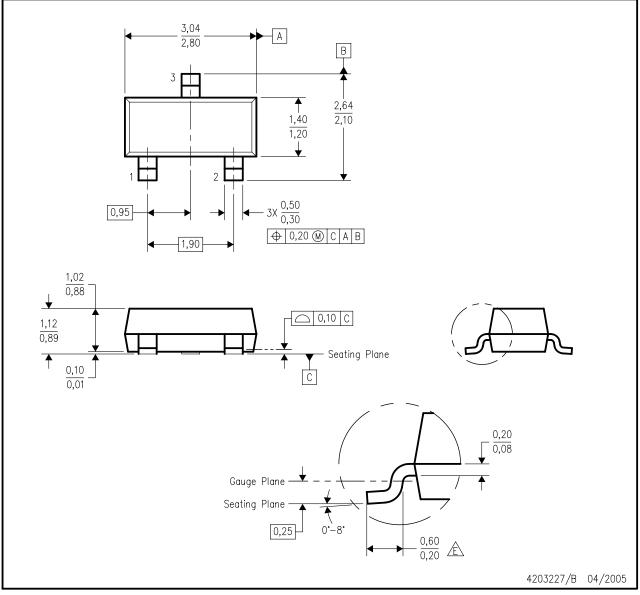
| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM809M3-2.63       | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-2.63/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-2.93       | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-2.93/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-3.08       | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-3.08/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-4.38/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3-4.63/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM809M3X-2.63/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| LM809M3X-2.93/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| LM809M3X-3.08/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| LM809M3X-4.38/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| LM809M3X-4.63/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| LM810M3-4.63       | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM810M3-4.63/NOPB  | SOT-23       | DBZ             | 3    | 1000 | 210.0       | 185.0      | 35.0        |
| LM810M3X-4.63/NOPB | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |



# **MECHANICAL DATA**

# DBZ (R-PDSO-G3)

PLASTIC SMALL-OUTLINE



NOTES:

Α. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- Β. This drawing is subject to change without notice.
- C.
- Lead dimensions are inclusive of plating. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side. D.
- È Falls within JEDEC TO-236 variation AB, except minimum foot length.





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